

PATENT ASSIGNMENT

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SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT
CONVEYING PARTY DATA	
Name	Execution Date
Haizhou YIN	11/14/2011
Zhijiong LUO	11/14/2011
Huilong ZHU	11/14/2011
RECEIVING PARTY DATA	
Name:	The Institute of Microelectronics, Chinese Academy of Sciences
Street Address:	No. 3 Beitucheng West Road,
Internal Address:	Chaoyang District
City:	Beijing
State/Country:	CHINA
Postal Code:	100029
PROPERTY NUMBERS Total: 1	
Property Type	Number
Application Number:	13380654
CORRESPONDENCE DATA	
Fax Number:	(202)739-3001
Phone:	2027393000
Email:	patents@morganlewis.com, kcasavecchia@morganlewis.com
<i>Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent via US Mail.</i>	
Correspondent Name:	Robert J. Gaybrick
Address Line 1:	1111 Pennsylvania Avenue NW
Address Line 4:	Washington, DISTRICT OF COLUMBIA 20004
ATTORNEY DOCKET NUMBER:	020275-5005
NAME OF SUBMITTER:	Robert J. Goodell
Total Attachments: 2 source=020275-5005_Assignment_12232011#page1.tif source=020275-5005_Assignment_12232011#page2.tif	

CH \$40.00 13380654

ATTORNEY DOCKET NO.:
SOLE/JOINT INVENTION
(U.S. Rights Only)

ASSIGNMENT

WHEREAS I/We, the below named inventor(s), [hereinafter referred to as Assignor(s)], have made an invention entitled:

SEMICONDUCTOR STRUCTURE AND METHOD FOR MANUFACTURING THE SAME

for which I/WE executed an application for United States Letters Patent concurrently herewith; or filed an application for United States Letters Patent on _____, (Application No. _____); and

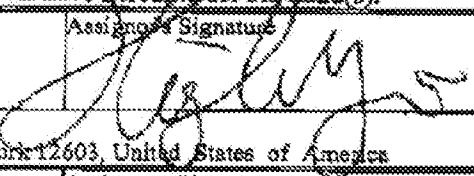
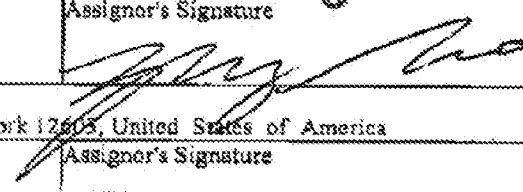
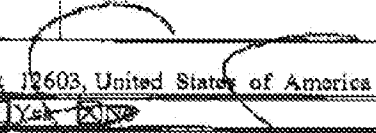
WHEREAS, The Institute of Microelectronics, Chinese Academy of Sciences, a corporation of P.R.China, whose post office address is No. 3 Beitucheng West Road, Chaoyang District, Beijing 100029, P.R.China, (hereinafter referred to as Assignee), is desirous of securing the entire right, title, and interest in and to this invention, the application for United States Letters Patent on this invention and the Letters Patent to issue upon this application;

NOW THEREFORE, be it known that, for good and valuable consideration the receipt of which from assignee is hereby acknowledged, I/WE, as assignor(s), have sold, assigned, transferred, and set over, and do hereby sell, assign, transfer, and set over unto the assignee, its lawful successors and assigns, MY/OUR entire right, title, and interest in and to this invention and this application, and all divisions, and continuations thereof, and all Letters Patent of the United States which may be granted thereon, and all reissues thereof; and I/WE hereby authorize and request the Commissioner of Patents and Trademarks of the United States to issue all Letters Patent for this invention to assignee, its successors and assigns, in accordance with the terms of this Assignment;

AND, I/WE HEREBY further covenant and agree that I/WE will, without further consideration, communicate with assignee, its successors and assigns, any facts known to ME/US respecting this invention and testify in any legal proceeding, sign all lawful papers when called upon to do so, execute and deliver all papers that may be necessary or desirable to perfect the title to this invention in said assignee, its successors and assigns, execute all divisional, continuation, and reissue applications, make all rightful oaths and generally do everything possible to aid assignee, its successors and assigns, to obtain and enforce proper patent protection for this invention in the United States, it being understood that any expense incident to the execution of such papers shall be borne by the assignee, its successors and assigns.

AND, I/WE HEREBY authorize and request the attorneys I/WE have empowered in the Declaration and Power of Attorney in this application, to insert here in parenthesis (Application No. 13/380,654, filed Dec. 23, 2011) the filing date and application number of said application when known.

IN TESTIMONY WHEREOF, I/WE have hereunto set our hand(s).

Full Name of Sole or First Assignor YEN, Haizhou	Assignor's Signature 	Date 11/14/2011
Address 11 Rockcrest Place, Poughkeepsie, New York 12603, United States of America		Citizenship China
Full Name of Second Assignor LUO, Zhijiong	Assignor's Signature 	Date 11/14/2011
Address 11 Rockcrest Place, Poughkeepsie, New York 12603, United States of America		Citizenship United States
Full Name of Third Assignor ZHU, Huilong	Assignor's Signature 	Date 11/14/2011
Address 93 Autumn Dr., Poughkeepsie, New York 12603, United States of America		Citizenship United States
Names of additional inventors attached	Yes <input checked="" type="checkbox"/>	